# N-Channel Enhancement-Mode Vertical DMOS FETs

## Ordering Information

| $BV_{DSS}$ / $BV_{DGS}$ | $R_{DS(ON)}$ (max) | $I_{D(ON)}$ (min) | $V_{GS(th)}$ (max) | Order Number / Package |
|---|---|---|---|---|
| | | | | TO-92 |
| 60V | 1.5Ω | 3.0A | 2.0V | TN0606N3 |
| 100V | 1.5Ω | 3.0A | 2.0V | TN0610N3 |

## Features

- ❏ Low threshold — 2.0V max.
- ❏ High input impedance
- ❏ Low input capacitance — 100pF typical
- ❏ Fast switching speeds
- ❏ Low on resistance
- ❏ Free from secondary breakdown
- ❏ Low input and output leakage
- ❏ Complementary N- and P-channel devices

## Low Threshold DMOS Technology

These low threshold enhancement-mode (normally-off) transistors utilize a vertical DMOS structure and Supertex's well-proven silicon-gate manufacturing process. This combination produces devices with the power handling capabilities of bipolar transistors and with the high input impedance and positive temperature coefficient inherent in MOS devices. Characteristic of all MOS structures, these devices are free from thermal runaway and thermally-induced secondary breakdown.

Supertex's vertical DMOS FETs are ideally suited to a wide range of switching and amplifying applications where very low threshold voltage, high breakdown voltage, high input impedance, low input capacitance, and fast switching speeds are desired.

## Applications

- ❏ Logic level interfaces – ideal for TTL and CMOS
- ❏ Solid state relays
- ❏ Battery operated systems
- ❏ Photo voltaic drives
- ❏ Analog switches
- ❏ General purpose line drivers
- ❏ Telecom switches

## Absolute Maximum Ratings

| | |
|---|---|
| Drain-to-Source Voltage | $BV_{DSS}$ |
| Drain-to-Gate Voltage | $BV_{DGS}$ |
| Gate-to-Source Voltage | ± 20V |
| Operating and Storage Temperature | -55°C to +150°C |
| Soldering Temperature* | 300°C |

* Distance of 1.6 mm from case for 10 seconds.

## Package Option

S G D

TO-92

Note:
1. See Package Outline section for dimensions

01/06/03

# Thermal Characteristics

| Package | $I_D$ (continuous)* | $I_D$ (pulsed) | Power Dissipation @ $T_C$ = 25°C | $\theta_{jc}$ °C/W | $\theta_{ja}$ °C/W | $I_{DR}$* | $I_{DRM}$ |
|---|---|---|---|---|---|---|---|
| TO-92 | 0.5A | 3.2A | 1W | 125 | 170 | 0.5A | 3.2A |

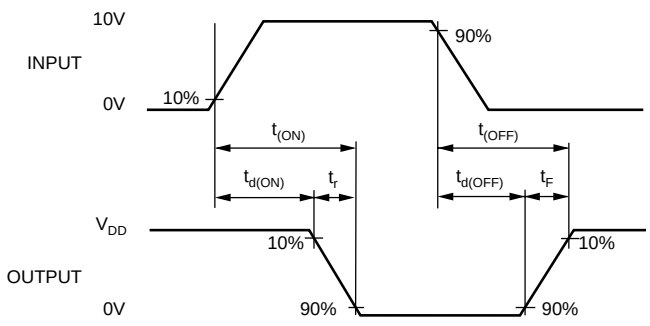
* $I_D$ (continuous) is limited by max rated $T_j$.

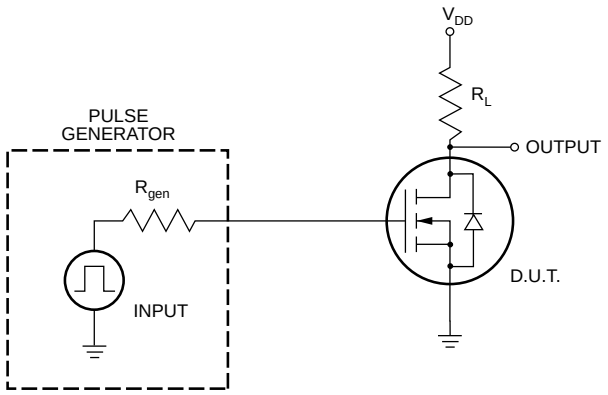
# Electrical Characteristics (@ 25°C unless otherwise specified)

| Symbol | Parameter | | Min | Typ | Max | Unit | Conditions |
|---|---|---|---|---|---|---|---|
| $BV_{DSS}$ | Drain-to-Source Breakdown Voltage | TN0610 | 100 | | | V | $V_{GS}$ = 0V, $I_D$ = 1mA |
| | | TN0606 | 60 | | | | |
| $V_{GS(th)}$ | Gate Threshold Voltage | | 0.6 | | 2.0 | V | $V_{GS}$ = $V_{DS}$, $I_D$ = 1mA |
| $\Delta V_{GS(th)}$ | Change in $V_{GS(th)}$ with Temperature | | | | -4.5 | mV/°C | $V_{GS}$ = $V_{DS}$, $I_D$ = 1mA |
| $I_{GSS}$ | Gate Body Leakage | | | | 100 | nA | $V_{GS}$ = ±20V, $V_{DS}$ = 0V |
| $I_{DSS}$ | Zero Gate Voltage Drain Current | | | | 10 | μA | $V_{GS}$ = 0V, $V_{DS}$ = Max Rating |
| | | | | | 1.0 | mA | $V_{GS}$ = 0V, $V_{DS}$ = 0.8 Max Rating $T_A$ = 125°C (note 2) |
| $I_{D(ON)}$ | ON-State Drain Current | | 1.2 | 2.0 | | A | $V_{GS}$ = 5V, $V_{DS}$ = 25V |
| | | | 3.0 | 6.7 | | | $V_{GS}$ = 10V, $V_{DS}$ = 25V |
| $R_{DS(ON)}$ | Static Drain-to-Source ON-State Resistance | | | | 15 | Ω | $V_{GS}$ = 3V, $I_D$ = 0.25A |
| | | | | 1.5 | 2.0 | | $V_{GS}$ = 5V, $I_D$ = 0.75A |
| | | | | 1.0 | 1.5 | | $V_{GS}$ = 10V, $I_D$ = 0.75A |
| $\Delta R_{DS(ON)}$ | Change in $R_{DS(ON)}$ with Temperature | | | | 0.75 | %/°C | $V_{GS}$ = 10V, $I_D$ = 0.75A |
| $G_{FS}$ | Forward Transconductance | | 0.4 | 0.5 | | ℧ | $V_{DS}$ = 25V, $I_D$ = 1.0A |
| $C_{ISS}$ | Input Capacitance | | | 100 | 150 | pF | $V_{GS}$ = 0V, $V_{DS}$ = 25V f = 1 MHz |
| $C_{OSS}$ | Common Source Output Capacitance | | | 50 | 85 | | |
| $C_{RSS}$ | Reverse Transfer Capacitance | | | 10 | 35 | | |
| $t_{d(ON)}$ | Turn-ON Delay Time | | | | 6 | ns | $V_{DD}$ = 25V $I_D$ = 1.5A $R_{GEN}$ = 25Ω |
| $t_r$ | Rise Time | | | | 14 | | |
| $t_{d(OFF)}$ | Turn-OFF Delay Time | | | | 16 | | |
| $t_f$ | Fall Time | | | | 16 | | |
| $V_{SD}$ | Diode Forward Voltage Drop | | | 0.8 | 1.8 | V | $V_{GS}$ = 0V, $I_{SD}$ = 1.5A |
| $t_{rr}$ | Reverse Recovery Time | | | 300 | | ns | $V_{GS}$ = 0V, $I_{SD}$ = 1.5A |

**Notes:**
1. All D.C. parameters 100% tested at 25°C unless otherwise stated. (Pulse test: 300μs pulse, 2% duty cycle.)
2. All A.C. parameters sample tested.

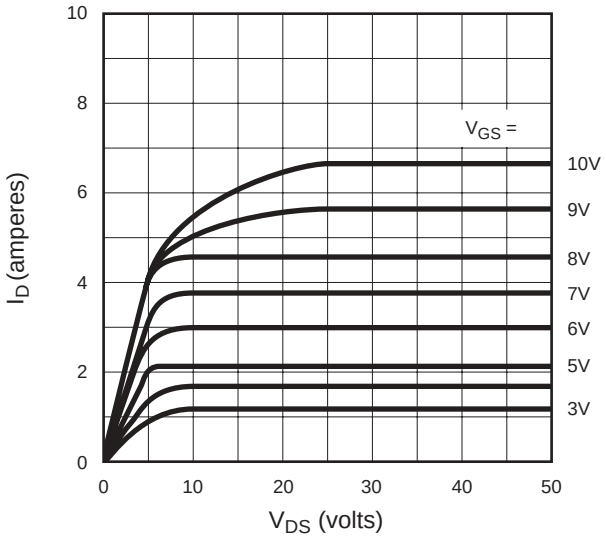
# Switching Waveforms and Test Circuit



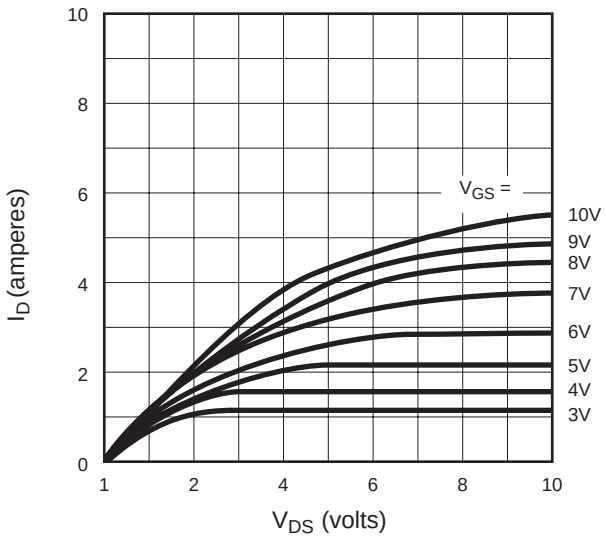



# Typical Performance Curves

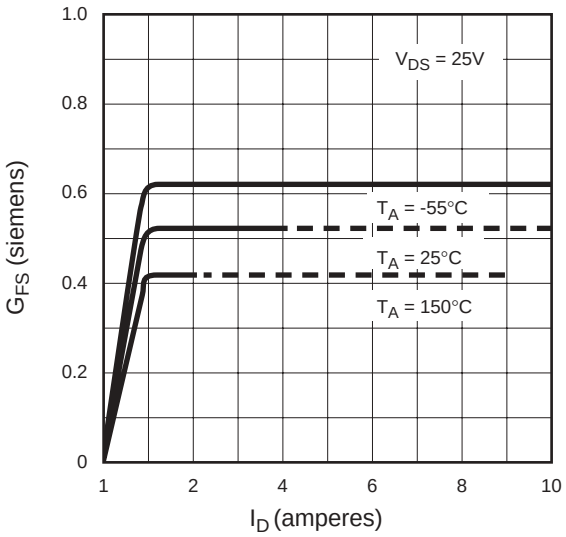
Output Characteristics



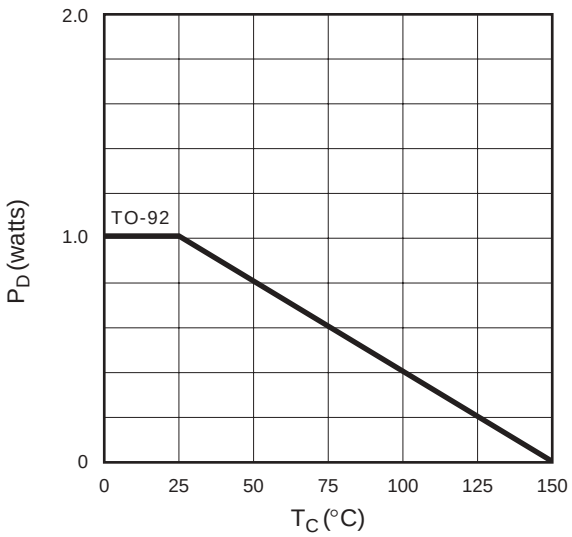

Saturation Characteristics



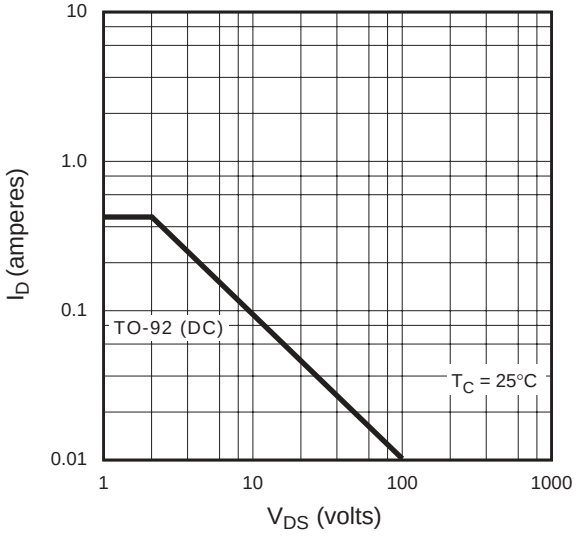

Transconductance vs. Drain Current



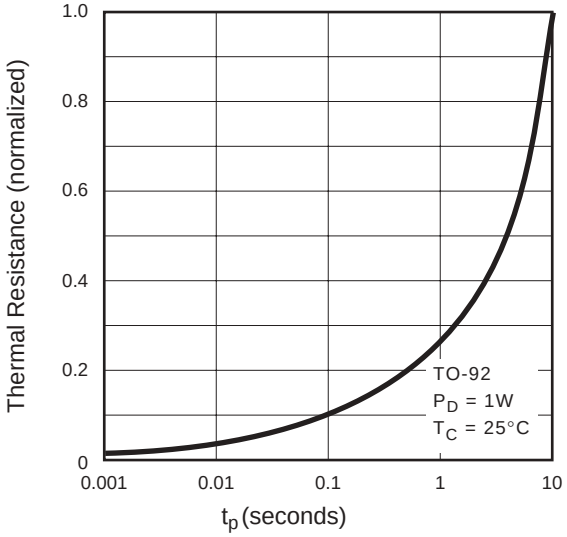

Power Dissipation vs. Case Temperature




Maximum Rated Safe Operating Area

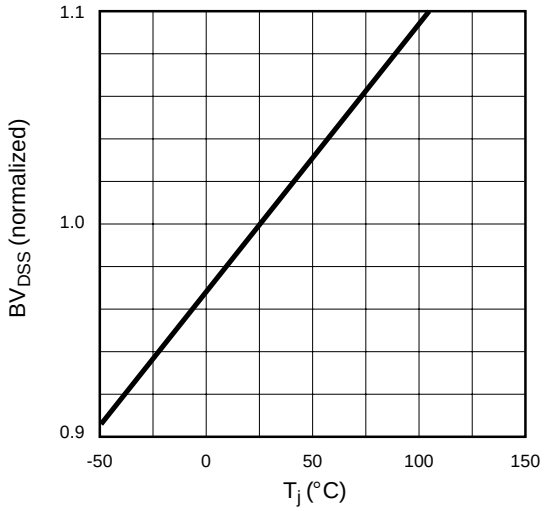



Thermal Response Characteristics

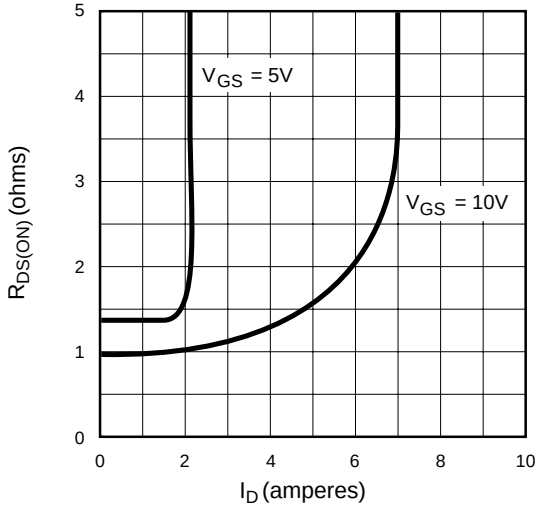


# Typical Performance Curves

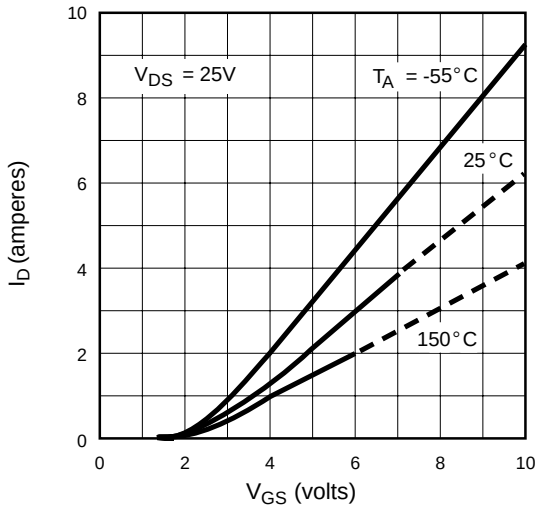
$BV_{DSS}$ Variation with Temperature



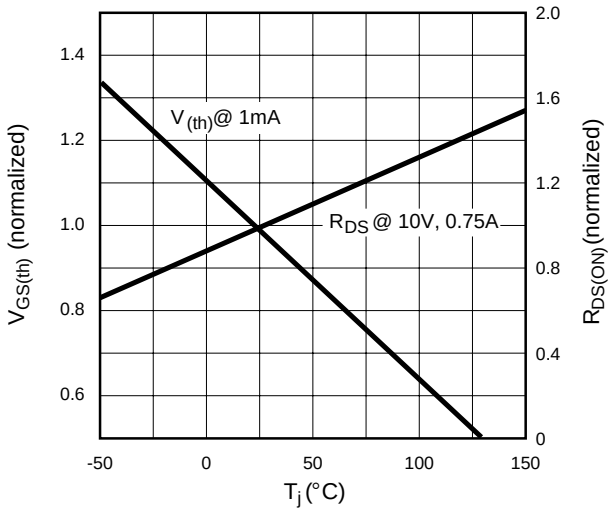

On-Resistance vs. Drain Current



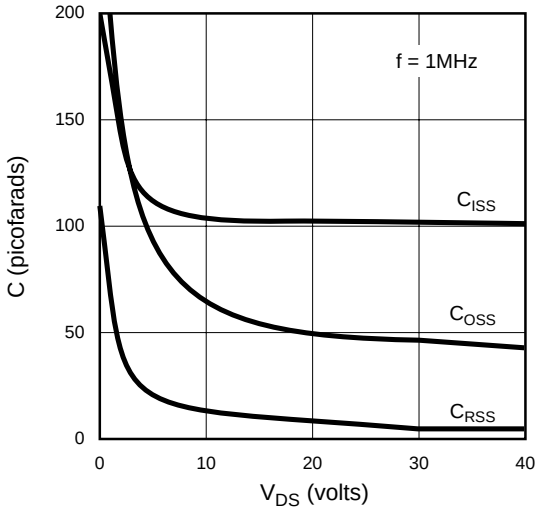

Transfer Characteristics



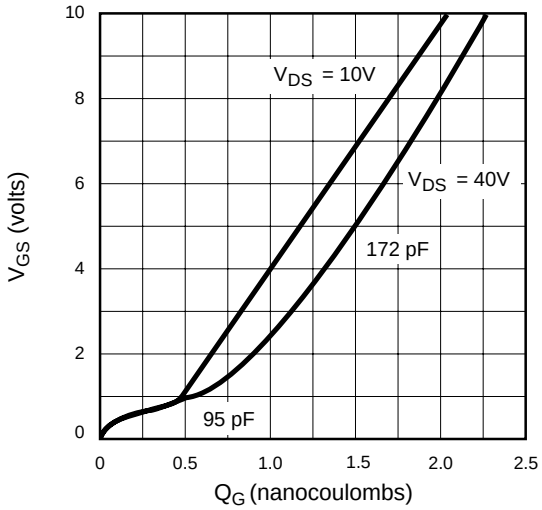

$V_{(th)}$ and $R_{DS}$ Variation with Temperature




Capacitance vs. Drain-to-Source Voltage




Gate Drive Dynamic Characteristics




01/06/03

Supertex inc.



1235 Bordeaux Drive, Sunnyvale, CA 94089
TEL: (408) 744-0100 • FAX: (408) 222-4895
www.supertex.com